



S/C Bus Fabrication, Assembly, Integration & Test

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Top Level Requirements (1 of 2)

- Define and Implement a System Test Program That Qualifies FAME Flight Hardware For All Handling, Transportation, Launch, and Mission Environments
 - Environmental Tests and Levels Defined in NCST-TP-FM001, *FAME Integration & Test Plan*
- All Flight Hardware Activities Comply With SSD-D-FM005, FAME Product Assurance Plan
 - Includes Traceability Requirements
 - Includes Control of Non-conforming Materials
 - Includes Failure Reporting and Corrective Action System



Top Level Requirements (2 of 2)

- All Flight Hardware Activities Comply With SSD-D-FM006, *FAME Safety, Reliability & Quality Assurance Plan*
- Maintain FAME Flight Hardware Cleanliness Levels As Specified in NCST-D-FM007, *FAME Contamination Control Plan*, Through All Phases of Assembly, Integration, Test, Transportation, and Field Operations
- Configuration Control Shall Be in Accordance With NCST-D-FM008, *FAME Configuration Management Plan*
- FAME Flight Hardware Shall Be Protected During Ground Handling and Transportation So That the Environmental Conditions to Not Exceed Flight or Orbital Conditions



Manufacturing Controls



- **Production Control**
 - **Build and Inspect Flight Hardware Only to Released and Configuration Controlled Assembly Drawings (And Any Associated Procedures & Process Specifications)**
- **Quality Assurance**
 - **Quality Assurance Personnel Monitor Assembly Activities and Perform Formal Inspections of Completed Subassemblies and Assemblies**
- **Identification & Marking**
 - **Interchangeable Subassemblies Identified With Nameplates**
 - **Where Practical, Components Will Be Marked With Part Number & Serial Number**
 - **Test Articles Permanently Marked “Not For Flight Use”**



Configuration Management

- Configuration Control Per FAME Configuration Management Plan, NCST-D-FM008
 - Formal System For Identification, Change Control, and Accounting of All Hardware and Software Defined As a Configuration Item
 - Configuration Change Notices (CCN's)
 - Primary Vehicle for Initiating Changes to Configuration Items
 - Submitted to the Configuration Control Board for Review
- As Built Configuration Lists (ABCL)
 - Generated by Quality Assurance to Document Precise Configurations at Discrete Points in the I&T Flow
 - For Each Component Build
 - To Document Component or Assembly Configuration for Each Environmental Test

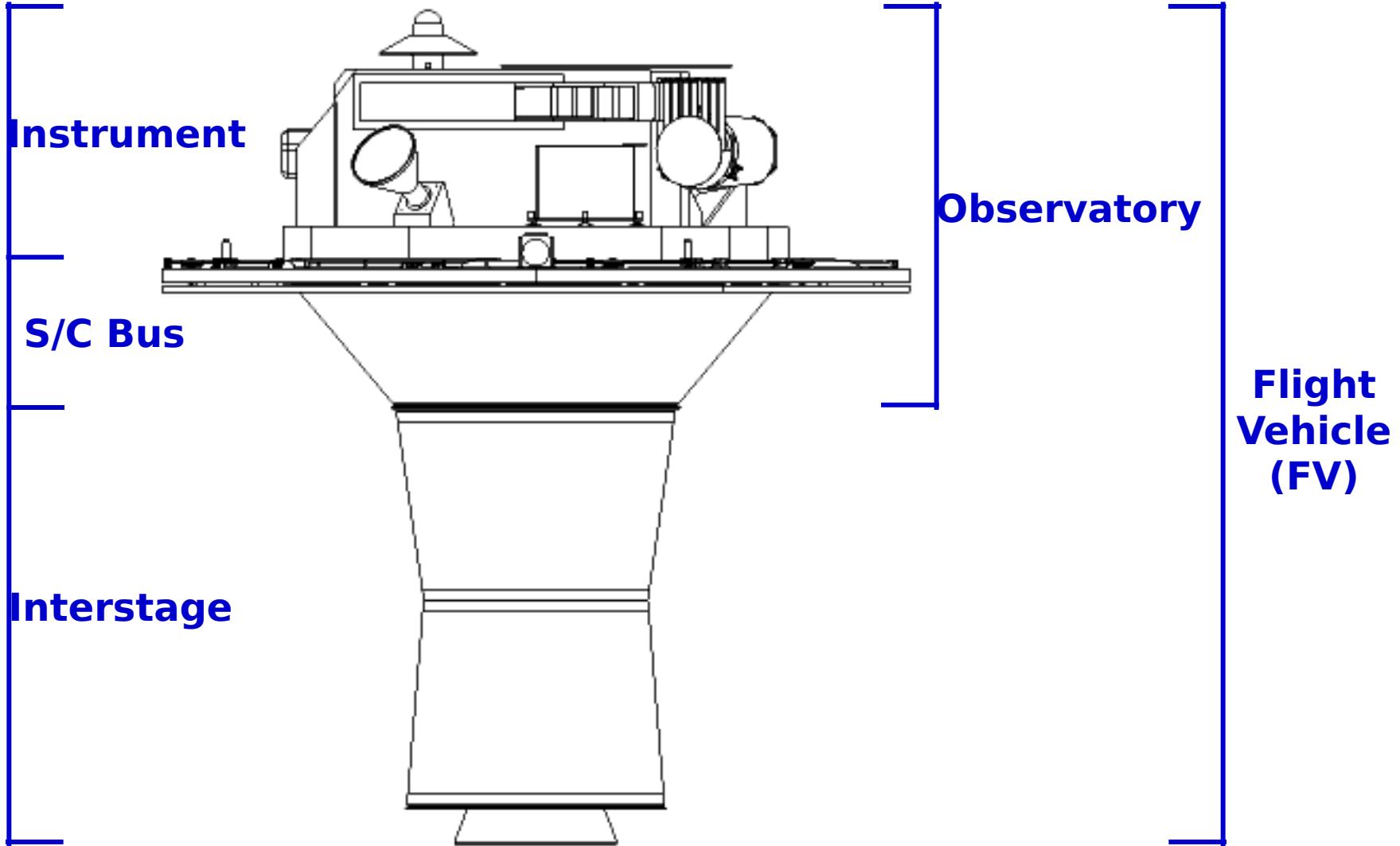


Build Documentation

- **Travelers (Fabrication Control Sheets) Are the Key Method for Flight Hardware Build Documentation**
 - **Uniquely Numbered Traveler Created For Each Manufactured Item and Assembly**
 - **Used to Document All Activities and Tests Performed on a Configuration Item**
 - **Travels With Hardware As It Passes Through All Phases of Fabrication, Assembly, Integration, and Test**
 - **Travelers Are the Primary Vehicle for Maintaining Flight Hardware Traceability**
 - **Retained As Part of Permanent Build File**
 - **Three Ring Binder “Logbooks” Are Often Created to Hold Travelers and All of the Supporting Documentation (Certifications, Procedures, Test Printouts and Reports, ABCL’s)**
- **Daily Logs of Activities Are Maintained By FAME Integration Team**

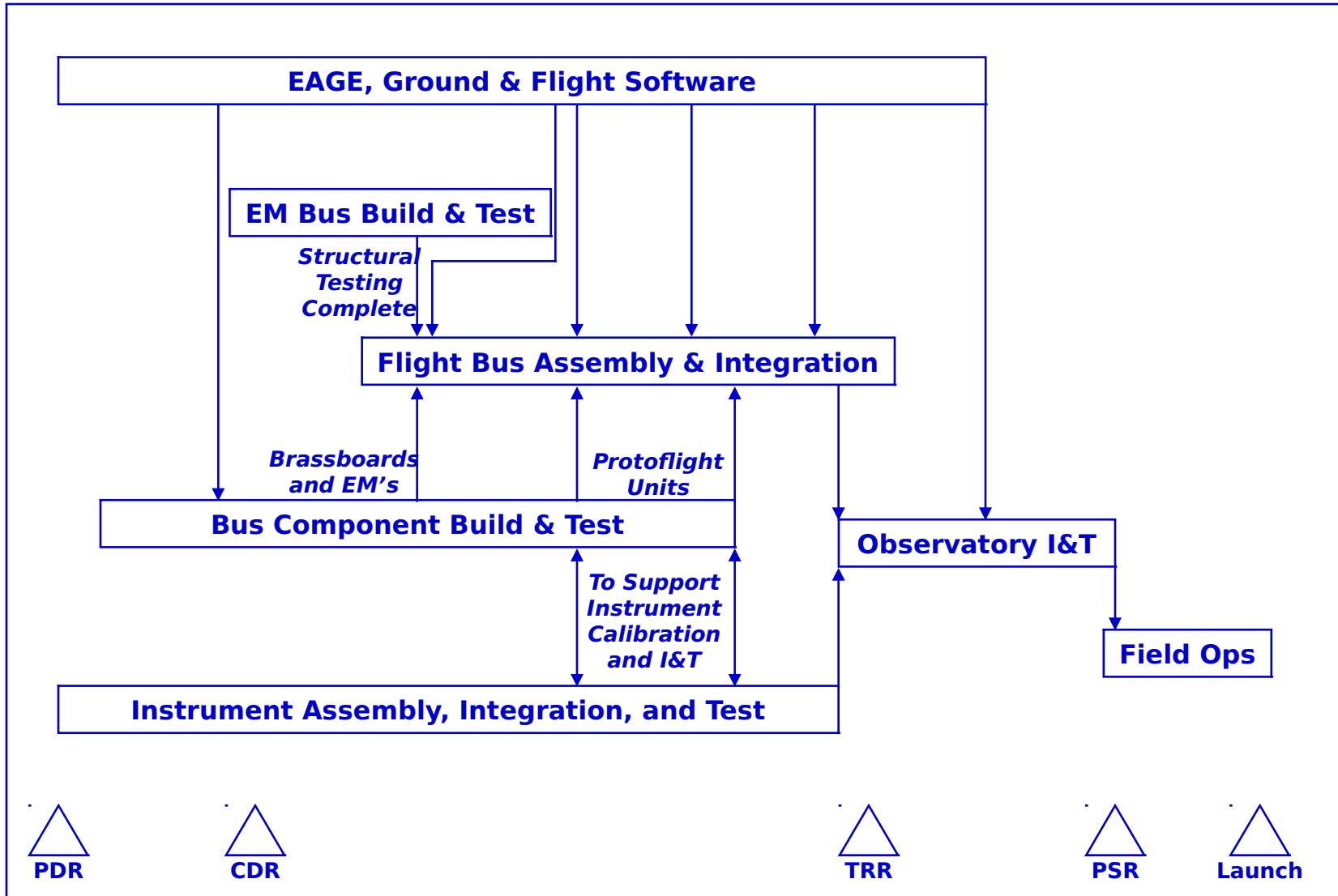


Assembly Nomenclature



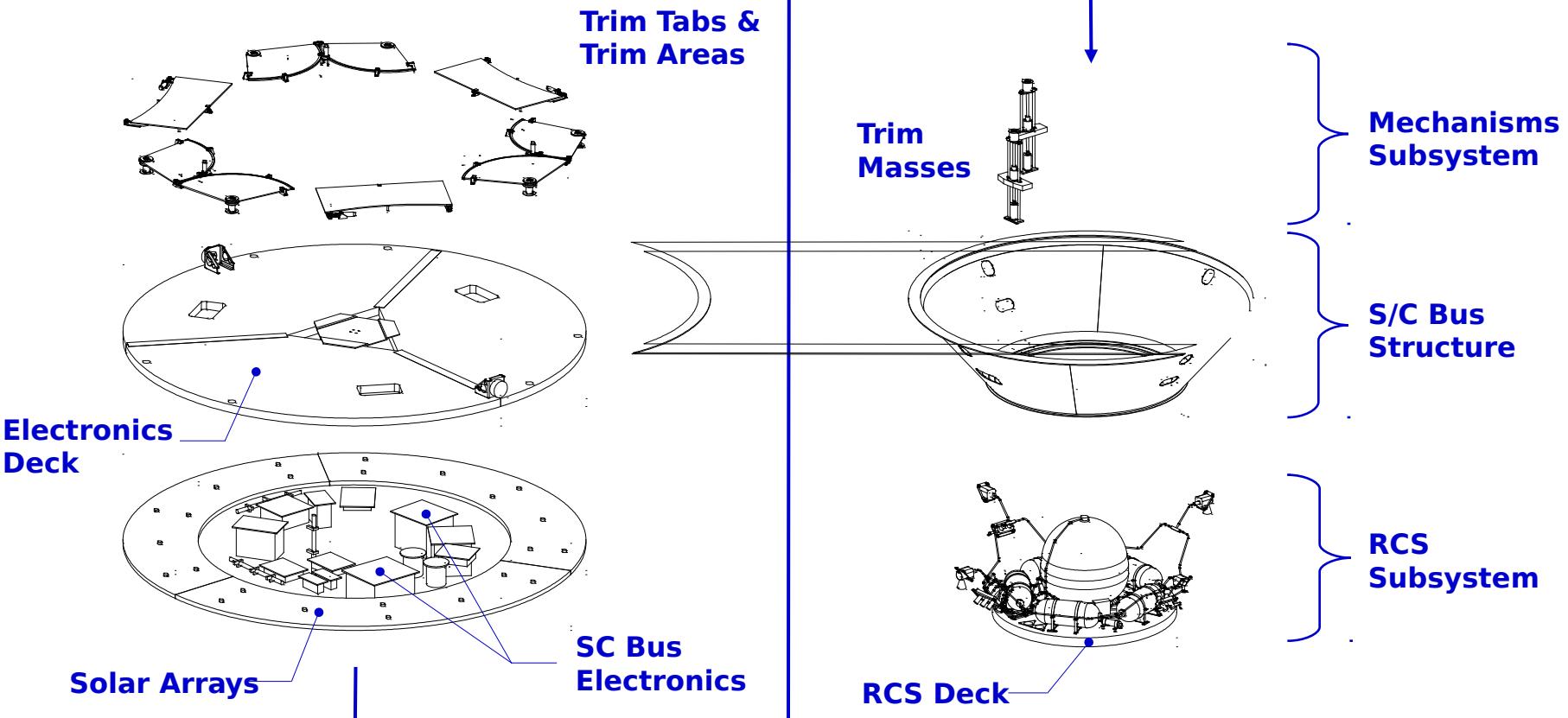


Observatory Development Flow





Bus Assembly Overview



- The FAME Bus is Designed for Modular Assembly & Integration
 - Ground Support Equipment (MAGE & EAGE), the Schedule, and Resource Allocation Support Parallel Build & Integration Efforts



Test Philosophy (1 of 2)

- Overall Philosophy for Test Program Is Based Upon the Protoflight Approach
 - Single Protoflight Spacecraft (& Components) Are Used for Design Qualification and for Flight
 - With Bus Structural Test Article (Engineering Model) to Reduce Risk & Free Up Flight Vehicle for Integration
 - Protoflight Spacecraft & Components Are Subjected to Environments More Severe Than Those Expected During the Mission
- Integration & Test Plan, NCST-TP-FM001, Defines a Comprehensive Test Program at the Component and the System Levels of Assembly
 - Specifies Tests to Be Performed
 - Specifies Prescribed Levels for Each Test
 - Contains Overall Program Environmental Test Matrix
 - Contains Test Verification Report Format
- Design, Loads, and Analysis Plan, NSCT-D-FM017
 - Defines Environments



Test Philosophy (2 of 2)

- Two Main Categories of Tests:
 - Functional and Performance Tests
 - Verify Electrical Systems/Software Operation
 - Verify Instrument Operation
 - Verify Mechanism Operation
 - Verify Propulsion System Function
 - Verify Thermal Design
 - Environmental Tests
 - Verify Ability to Survive Launch and On-Orbit Conditions
 - Vibration, Acoustic
 - Static Loads
 - Pyrotechnic Shock
 - Thermal Vacuum
 - EMI/EMC

Performance Test: Exercises All Parts of Hardware and Software, Verifies Every Function & Mode Possible. Performed at Low, Nominal & High Bus Voltages

Functional Test: Verifies All Hardware Connections & Basic Functionality. Typically Created by Removing Parts of Performance Test to Reduce Duration & Complexity



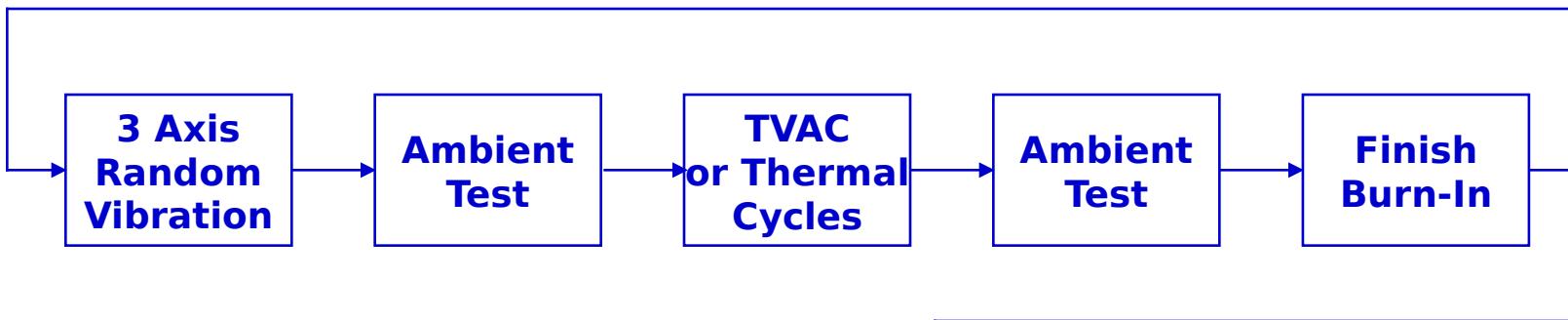
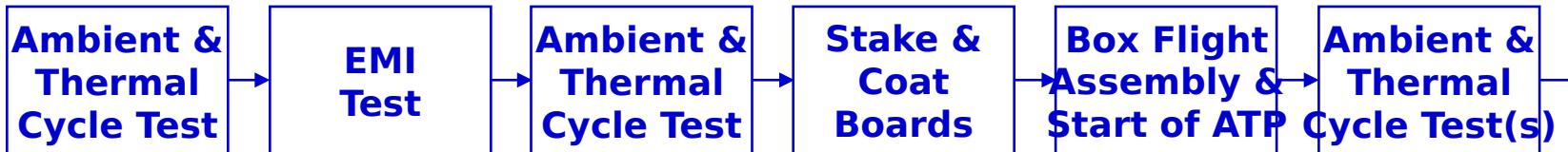
Component Testing Approach



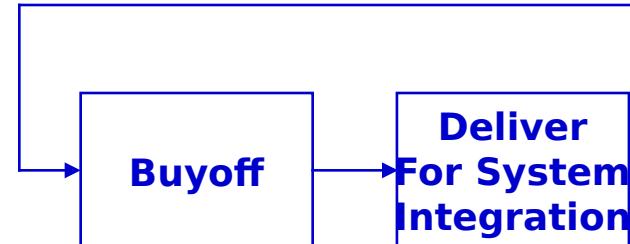
- **Functional and Performance Testing**
 - **Acceptance Test Programs (or Component Specifications for Purchased Items) Are Developed for Each Component**
 - **Incorporates Unique Functional & Performance Testing Requirements for Each Component**
 - **After the Successful Conclusion of Each Component ATP, a Buyoff Is Held Prior to Delivery of Unit for System Integration**
- **Environmental Testing**
 - **Minimum Test Requirements Defined in NCST-TP-FM001**
 - **Any Additional Testing Requirements Are Captured in the Component Acceptance Test Plan**



Generic Component Testing Flow



- All Temp Cycles are Run at Predicted Box Baseplate Temperature Extremes +/-10°C
- Ambient is 20-25°C
- 9 ATP Temperature Cycles
- 2 Hour Dwells at Extremes
- Minimum of 200 Hours ATP Test Time
- Final 50 Hours Failure Free
- Static Loads Qualification by Analysis or by Sine Burst Testing



Example Above is for
Protoflight Electronics
Box

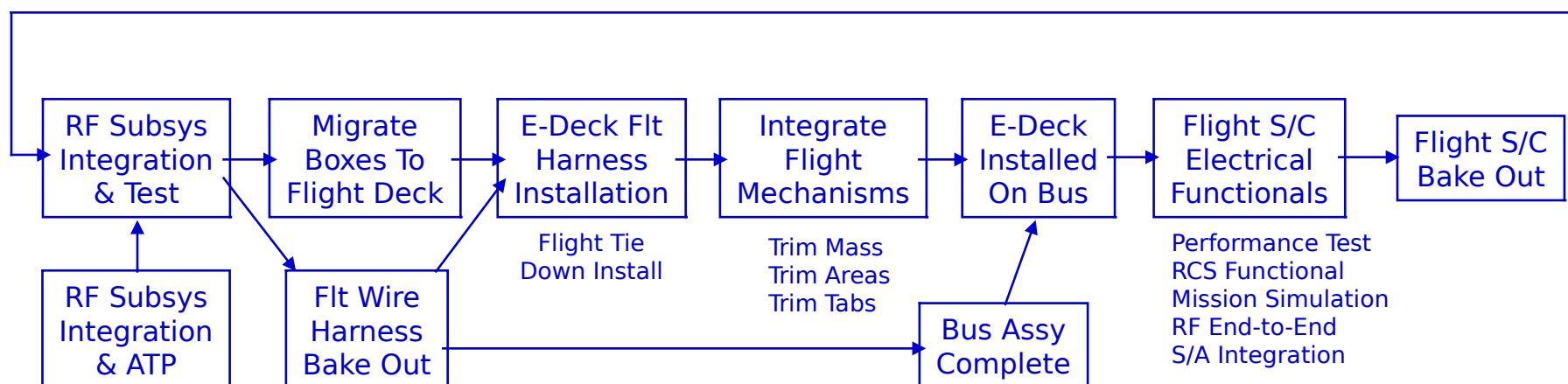
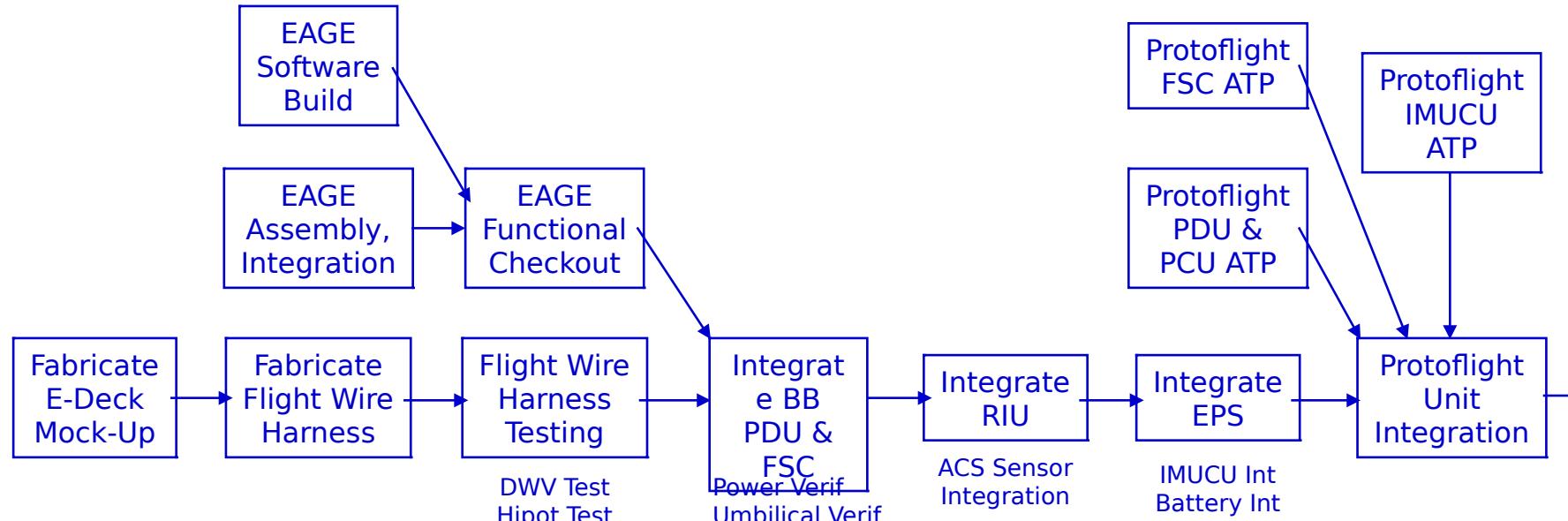


System Testing Approach

- **Electrical Functional and Performance Testing**
 - **An Electronics Deck Mechanical Mock-up Is Produced to Support Electrical I&T Activities**
 - **Initially, the Deck (Aluminum Honeycomb) Is Outfitted With Box Simulators and Used As Fixture for Wire Harness Fabrication**
 - **Box Simulators Are Replaced With Brassboard and Engineering Model Units As They Become Available. EAGE Is Connected Up and Ground Software Scripts Are Developed to Exercise Functions and Measure Performance**
 - **As Integration Progresses, Protoflight Units Replace Non-flight Units on the Mock-up Deck**
 - **The Flight Electronics and Harness Are Migrated to the Flight Electronics Deck When It Becomes Available**
 - **The Test Cases and Perform Files That Are Developed During the Electrical Integration and Test Activities Above Are Used to Develop the Functional & Performance Test Description Document**



Electrical/Software I&T Flow



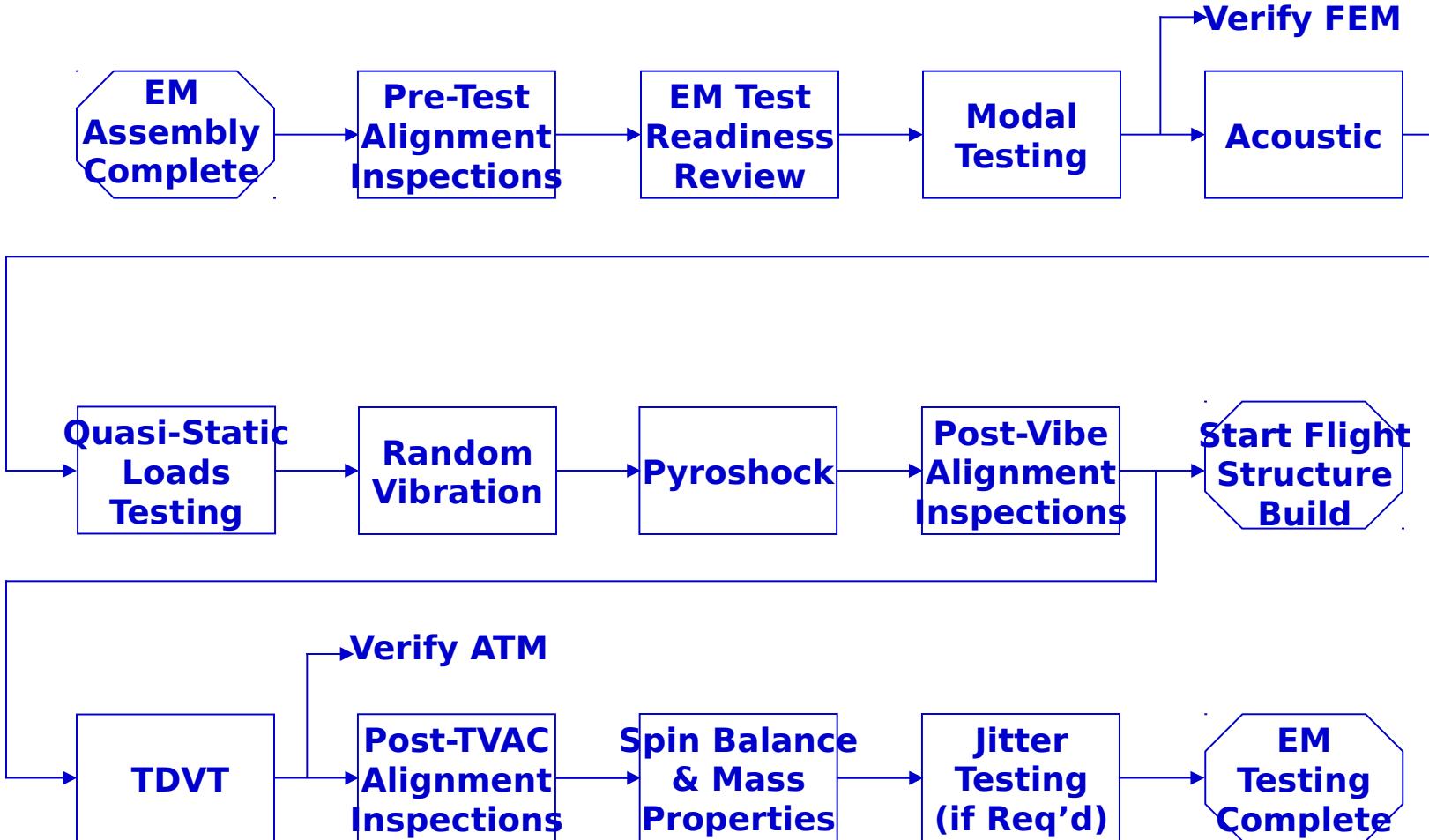


System Testing Approach

- **Environmental Testing**
 - An Engineering Model (EM) Structure Will Be Built and Populated With Mass Simulators for the Instrument, The AKM, and All Components
 - The EM Will Be Used For Modal Testing and For Structural Loads Qualification of the FAME Design
 - The EM Will Undergo Vibro-Acoustic Testing at the Qualification Level (Flight +6db for 2 Minutes/axis)
 - The EM Will Also Be Used For Pyroshock, TDVT, and As a Pathfinder For Alignments and Spin Balance
 - The EM Also Serves As a Pathfinder for Manufacturing, Handling, Test Procedures, and Fit Checks
 - Data From EM Testing Will Be Used to Verify FEM, Verify ATM, & Revise Component and Instrument Random Vibe and Shock Spectra
 - Flight Observatory Environmental Testing Is Covered in Following Section



EM Test Flow





Environmental Test Matrix

Level of Assembly	Item	Unit Type	Structural & Mechanical Testing												EMI/EMC						Thermal							
			Modal Survey	Loads Static or Quasi-Static	Random Vibration	Acoustic	Piezoelectric	Pitot Pressure	Leak	Mechanism Ratio	Torque Ratio	Life Testing	Sun Balance	Magnetic Balance	Conducted Emissions (CE01)	Conducted Susceptibility (CS01)	Conducted Susceptibility (CS02)	Conducted Susceptibility (CS03)	Conducted Susceptibility (CS04)	Conducted Susceptibility (CS05)	Conducted Susceptibility (CS06)	Radiated Emissions (RE02)	Electrostatic Discharge (ESD)	DC Power Output	Number of Thermal Cycles	Thermal Design Verification	Temperature Design Limits	Proflight Test Temperature Limits
P/L	Observatory/Flight Vehicle	PF	-	-	X	X	X	-	-	X	-	-	-	-	-	-	-	-	-	-	-	-	4	-	0/+40	10/+50		
I	Instrument	PF	X	-	X	-	-	-	-	X	X	-	X	-	-	-	-	-	-	-	-	-	4	X	-30/+25	-40/+35	Optics Temp Limit	
S/C	Flight Spacecraft Bus	PF	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	X	0/+40	-10/+50	
S	Bus & Interstage Structure	EM	X	X	X	X	X	-	X	-	X	-	-	-	-	-	-	-	-	-	-	-	-	X	0/+40	-10/+50		
RCS Subsystem																												
C	AKM	F	-	A/T	X	-	-	X	X	-	-	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-4/+32	-6/+42	
C	Propellant Tank	F	-	A/T	X	-	-	X	X	-	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+30	-3/+40	Dry Test Temp Limits
C	Pressurant Tank	F	-	A/T	X	-	-	X	X	-	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits
C	Thruster 5.0 Lb	F	-	A/T	X	-	-	X	X	X	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits
C	Thruster 0.2 Lb	F	-	A/T	X	-	-	X	X	X	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
C	Propellant Lines	PF	-	A/T	-	-	-	X	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
C	Fill Valves	F	-	A/T	X	-	-	X	X	X	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
C	Pressure Transducer	F	-	A/T	X	-	-	X	X	X	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
C	Propellant Filter	F	-	A/T	X	-	-	X	X	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
C	Propellant Latch Valve	F	-	A/T	X	-	-	X	X	X	Q	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
C	Pyro Isolation Valve	F	-	A/T	X	-	-	X	X	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-7/+40	-3/+50	Dry Test Temp Limits	
ADCS Subsystem																												
C	IMU	F	-	A/T	X	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-	-54/+71	64/+81		
C	Spinning Sun Sensors	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-10/+60	-20/+70		
C	Sun Sensor Electronics	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-10/+60	-20/+70		
C	Coarse Sun Sensor	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-125/+80	135/+90		
C	Torque Rods	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Magnetometers	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-30/+50	40/+60		
C	Star Trackers	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-15/+40	-25/+50	-15/+0 On-Orbit Limit	
C	Star Tracker DPU	F	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-0/+40	-10/+50		
Mechanism Subsystem																												
C	Trim Tabs	Q,F	-	A/T	X	-	-	-	X	X	Q	-	X	X	-	X	X	X	X	X	X	9	-	-180/+40	-90/+50	-40/+80 Motor Limit		
C	Trim Areas	Q,F	-	A/T	X	-	-	-	X	X	Q	-	X	X	-	-	X	X	X	X	X	X	9	-	-80/+40	-90/+50	-40/+80 Motor Limit	
C	Trim Masses	Q,F	-	A/T	X	-	-	-	X	X	Q	-	X	X	-	-	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Kickoff Canisters	Q,F	-	A/T	X	-	-	-	X	X	Q	-	-	-	-	-	-	-	-	-	-	-	9	-	-20/+50	30/+60		
C	Marmon Clamp	Q,F	-	A/T	X	-	-	-	X	X	-	-	-	-	-	-	-	-	-	-	-	-	9	-	-20/+60	-30/+70		
EPS Subsystem																												
C	Solar Arrays	Q,F	-	X	-	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	4	-	-80/+100	90/+110		
C	Battery	Q,F	-	A/T	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	4	-	-0/+30	-10/+40		
C	PDU	PF	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	PCU	PF	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	SAI B	PF	-	A/T	X	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	9	-	-0/+40	-10/+50		
C	BCB	PF	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Safe/Arm Box	PF	-	A/T	X	-	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	9	-	-0/+40	-10/+50		
S	Harness	PF	-	A/T	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	X	-20/+60	-30/+70			
RF System																												
C	Transponder	PF	-	A/T	X	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Diplexer	F	-	A/T	X	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Hybrid/Coupler	F	-	A/T	X	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Antennas	Q,F	-	A/T	X	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	9	-	-30/+70	40/+80		
C	Transfer Switches	F	-	A/T	X	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	SPDT Switches	F	-	A/T	X	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	Gore Cables	PF	-	A/T	-	-	-	-	-	X	X	X	X	X	X	X	X	X	X	X	X	X	-	-20/+60	-30/+70			
CTSDH Subsystem																												
C	FSC	PF	-	A/T	X	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
C	IRIU	F	-	A/T	X	-	-	-	-	X	X	-	X	X	-	-	X	X	X	X	X	X	9	-	-0/+40	-10/+50		
TCS Subsystem																												
C	MLI Blankets	PF	-	A/T	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	X	125/+125	135/+135			



Bus Schedule (1 of 2)



A Gantt chart illustrating activity timelines across four phases. The horizontal axis represents time, with vertical grid lines indicating specific points. The vertical axis lists activities.

Activity ID	Activity Description	Start Type	Finish
A	Activity A	Start	End
B	Activity B	Start	End
C	Activity C	Start	End
D	Activity D	Start	End
E	Activity E	Start	End
F	Activity F	Start	End
G	Activity G	Start	End
H	Activity H	Start	End
I	Activity I	Start	End
J	Activity J	Start	End
K	Activity K	Start	End
L	Activity L	Start	End
M	Activity M	Start	End
N	Activity N	Start	End
O	Activity O	Start	End
P	Activity P	Start	End
Q	Activity Q	Start	End
R	Activity R	Start	End
S	Activity S	Start	End
T	Activity T	Start	End
U	Activity U	Start	End
V	Activity V	Start	End
W	Activity W	Start	End
X	Activity X	Start	End
Y	Activity Y	Start	End
Z	Activity Z	Start	End

The chart shows the following activity timelines:

- Activity A: Starts at the beginning of Phase 1 and ends at the end of Phase 1.
- Activity B: Starts at the beginning of Phase 1 and ends at the end of Phase 2.
- Activity C: Starts at the beginning of Phase 1 and ends at the end of Phase 3.
- Activity D: Starts at the beginning of Phase 1 and ends at the end of Phase 4.
- Activity E: Starts at the beginning of Phase 2 and ends at the end of Phase 2.
- Activity F: Starts at the beginning of Phase 2 and ends at the end of Phase 3.
- Activity G: Starts at the beginning of Phase 2 and ends at the end of Phase 4.
- Activity H: Starts at the beginning of Phase 3 and ends at the end of Phase 3.
- Activity I: Starts at the beginning of Phase 3 and ends at the end of Phase 4.
- Activity J: Starts at the beginning of Phase 4 and ends at the end of Phase 4.
- Activity K: Starts at the beginning of Phase 1 and ends at the end of Phase 1.
- Activity L: Starts at the beginning of Phase 1 and ends at the end of Phase 2.
- Activity M: Starts at the beginning of Phase 1 and ends at the end of Phase 3.
- Activity N: Starts at the beginning of Phase 1 and ends at the end of Phase 4.
- Activity O: Starts at the beginning of Phase 2 and ends at the end of Phase 2.
- Activity P: Starts at the beginning of Phase 2 and ends at the end of Phase 3.
- Activity Q: Starts at the beginning of Phase 2 and ends at the end of Phase 4.
- Activity R: Starts at the beginning of Phase 3 and ends at the end of Phase 3.
- Activity S: Starts at the beginning of Phase 3 and ends at the end of Phase 4.
- Activity T: Starts at the beginning of Phase 4 and ends at the end of Phase 4.
- Activity U: Starts at the beginning of Phase 1 and ends at the end of Phase 1.
- Activity V: Starts at the beginning of Phase 1 and ends at the end of Phase 2.
- Activity W: Starts at the beginning of Phase 1 and ends at the end of Phase 3.
- Activity X: Starts at the beginning of Phase 1 and ends at the end of Phase 4.
- Activity Y: Starts at the beginning of Phase 2 and ends at the end of Phase 2.
- Activity Z: Starts at the beginning of Phase 2 and ends at the end of Phase 3.

Start Date	01JAN00		Early Bar
Finish Date	28JAN05		Progress Bar
Data Date	24OCT01		Critical Activity
Run Date	24OCT02 09:33		
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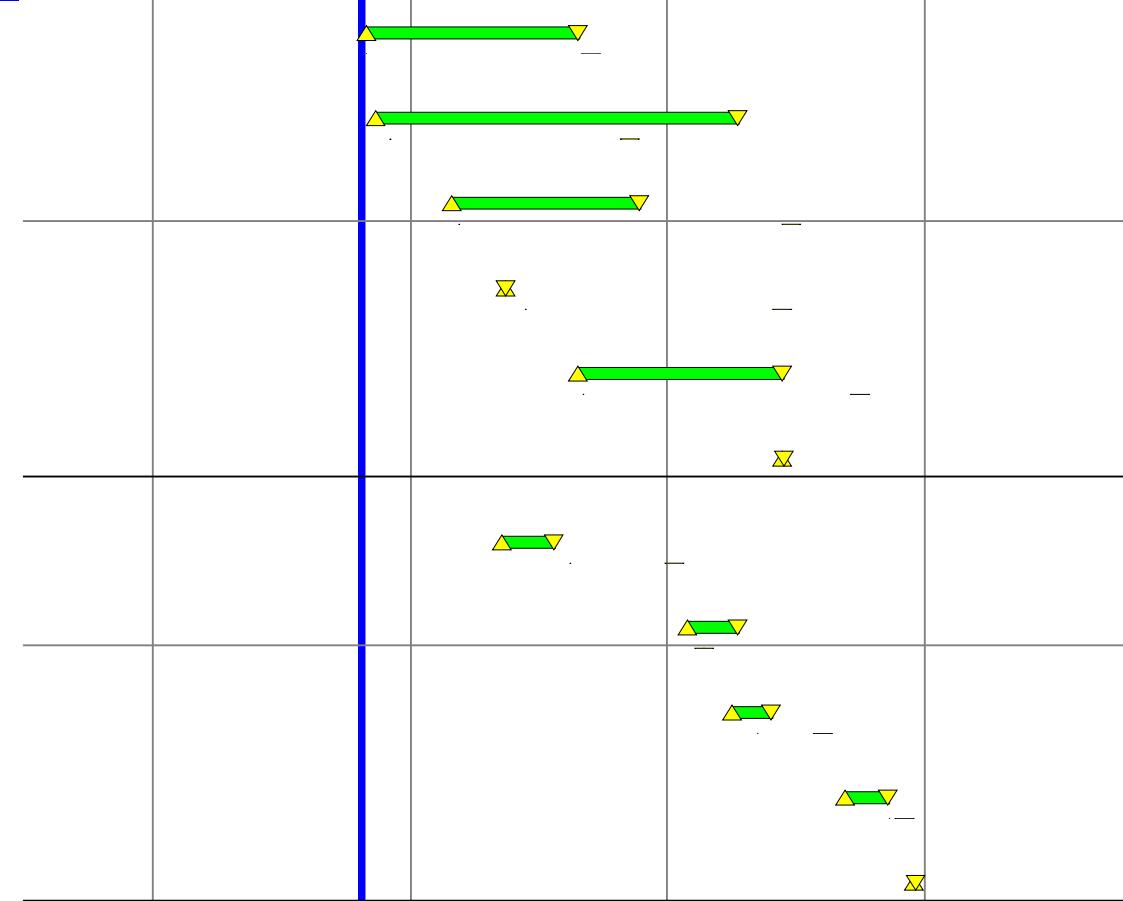
**FAME Project
Bus Development Summary
Schedule 10/31/01**

of 2	Date	Revision	Checked	Approved
y				



Bus Schedule (2 of 2)

Activity ID	Activity Description	Start Type	Finish
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S/C Bus I&T Issues

- **Bus Subsystem Mechanical Integration**
 - **As Design Matures, Need to Ensure That a Maximum Amount of Assembly Sequence Flexibility is Maintained**
- **Alignment Knowledge Requirement Verification**
 - **Use Engineering Model Alignments as Pathfinder & Develop Alignment Verification Plan for Flight Observatory**
- **Spin Balancing Observatory With Bag on Instrument**
 - **Potential for Errors Caused by Weight and Aerodynamics**
 - **Use EM Pathfinder Spin Balance to Assess Sensitivity**



Back-Up



I&T, MAGE Peer Review Summary



- **Reviewers:**

- John Ruffa
- Joe Hauser
- George Flach
- Russ Barnes
- Kiera Gallelli
- Aaron Chilbert
- David Spencer
- Mark Johnson
- Chris Garner
- Ron Mader

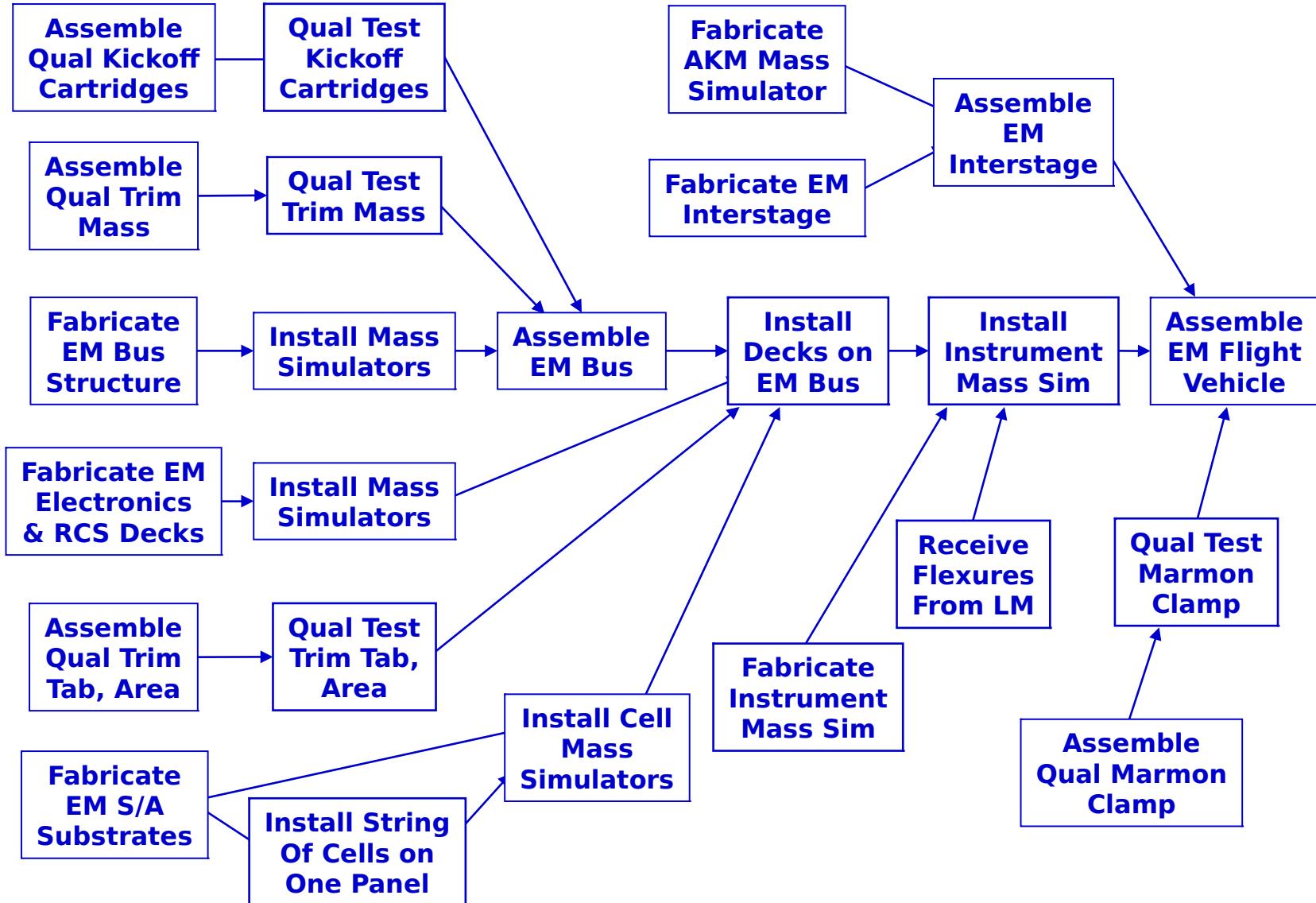
GSFC	Systems Engineer
NRL	Systems Engineer
NRL	Systems Engineer
BEI	Systems Engineer
NRL	NEMO Program I&T Lead
NRL	ICM Mechanical Systems Lead
NRL	WindSat Program Manager
NRL	FAME Program Manager
NRL	FAME Electrical Lead
NRL	FAME Mechanical Lead

- **Issues Addressed:**

- Ensure Availability of GSFC Loaned MAGE Hardware
- CG Location When Lifting Observatory Without Interstage
- Need Fixture for Lateral Moment of Inertia & Axial CG Measurements
- Provide Higher Level Overview of Bus/Observatory Development
- Detailed Test Matrix at PDR - Good



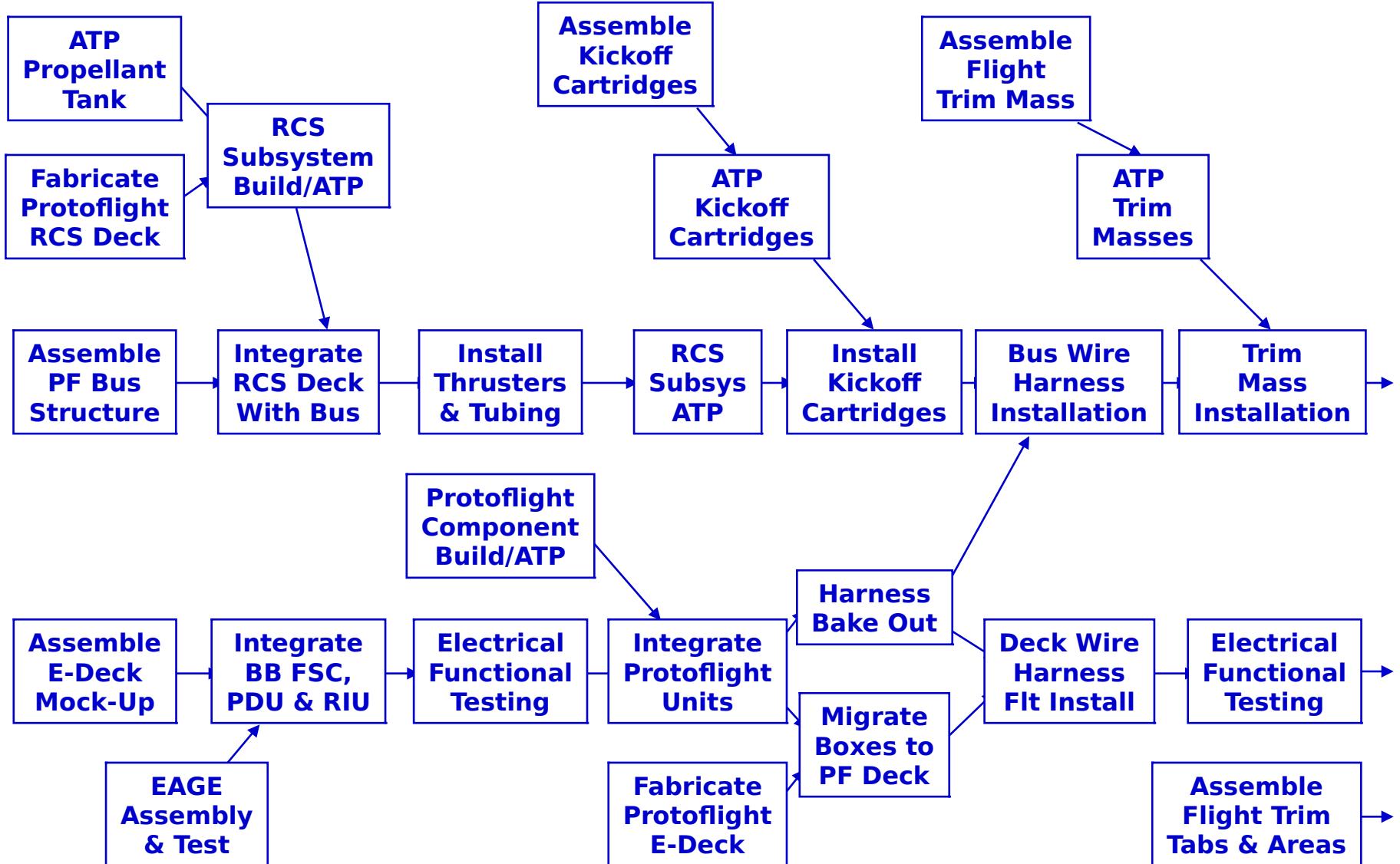
Engineering Model Assembly Flow





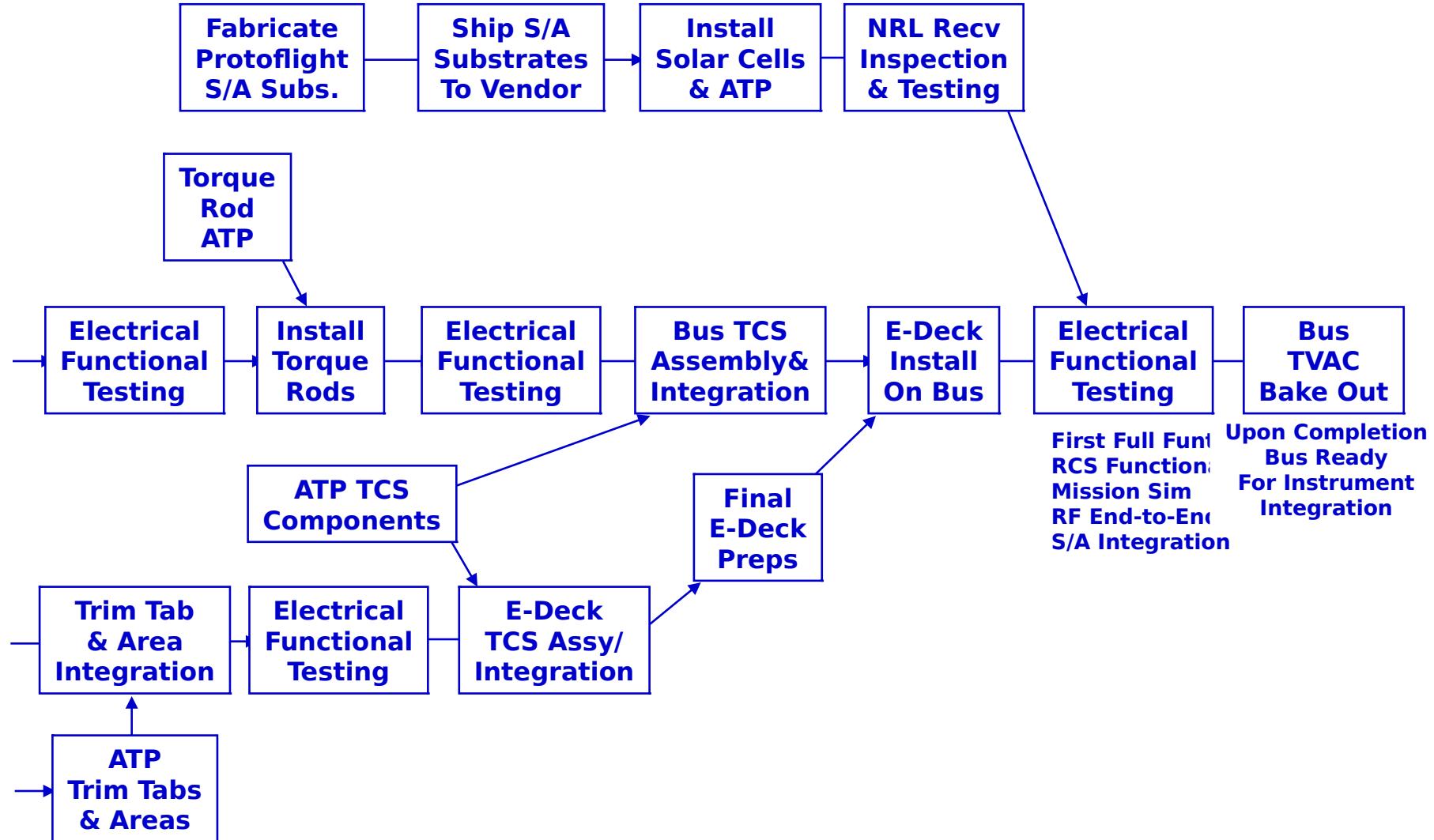
Flight Bus Assy & Integ Flow

(1 of 2)





Flight Bus Assy & Integ Flow (2 of 2)





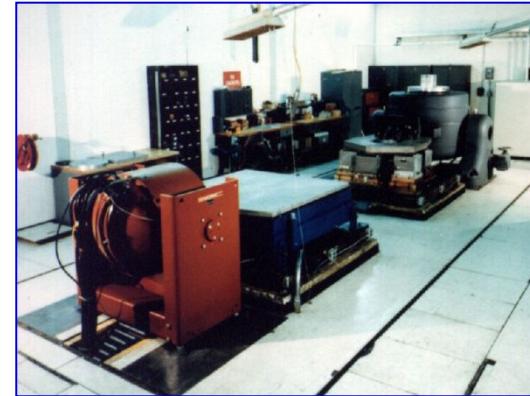
NRL Integration & Test Facilities



Anechoic Chambers



Acoustic Chamber



Vibration Laboratory



Spin Balance & MOI Machines



TVAC Chambers



Clean Rooms

- NRL Building A59 Contains All of the Facilities Necessary to Integrate and Test FAME Program Space Segment Hardware



United States Naval Observatory



LOCKHEED MARTIN

Facility Capabilities

Test	Parameter of Merit	Program Requirement	Capability
Clean Rooms	Class Rating	Class 1000	Class 100 and Class 1000
Alignment Inspections	Angular Resolution	± 10 Arc-Sec	± 4 Arc-Sec
Magnetic Balance	Magnetic Dipole Balance Capability	200 mA-m ² Per Axis	<150 mA-m ² Per Axis
EMI/EMC	Chamber Size & Test Equipment Capability	9' x 9' x 8' Per Test Plan	31' x 31' x 25' IAW Test Plan
Spin Balance	Unbalance Resolution & Load Capacity	>4 Oz-in ~2000 lb (w Fixt)	4 Oz-in at 60 RPM 18,000lb Capacity
Moments of Inertia	Measurement Accuracy & Load Capacity	$\pm 2\%$ Accuracy ~2000 lb (w Fixt)	$\pm 0.5\%$ Accuracy 3000 lb Capacity
Acoustic	Chamber Size & Overall SPL Capability	9' x 9' x 8' 142.7 dB	16' x 21' x 26' >150 dB
Vibration	Equipment Capability	~10,000 Force-Lb	18,000 and 35,000 Force-Lb
Thermal Vacuum	Size & Vacuum Level	9' x 9' x 8' 1×10^{-5} Torr	16' Diam. x 30 Lg $< 1 \times 10^{-6}$ Torr



Bldg A59 Clean Room Facilities



Facility	Best Cleanliness Level	Interior Size (L x W x H)	Entrance Size (W x H)
New Clean Room	Class 1000	44' x 23.7' x 20'	18' x 18'
Old Clean Room	Class 100*	35' x 29' x 10.5'	12' x 9.8'
Fixed Clean Tent	Class 100	17' x 17' x 18'	16' x 9'
Large Portable Clean Tent	Class 100	15' x 15' x 21'	15' x 20'
Small Portable Clean Tent	Class 1000	12' x 6' x 8'	12' x 7.5'

*Horizontal Flow Clean Room, Rating Applies Directly in Front of Filter Bank Only

FAME Observatory Dimensions:

- Height = 8.0 Feet (on Dolly)
- Diameter = 9.0 Feet



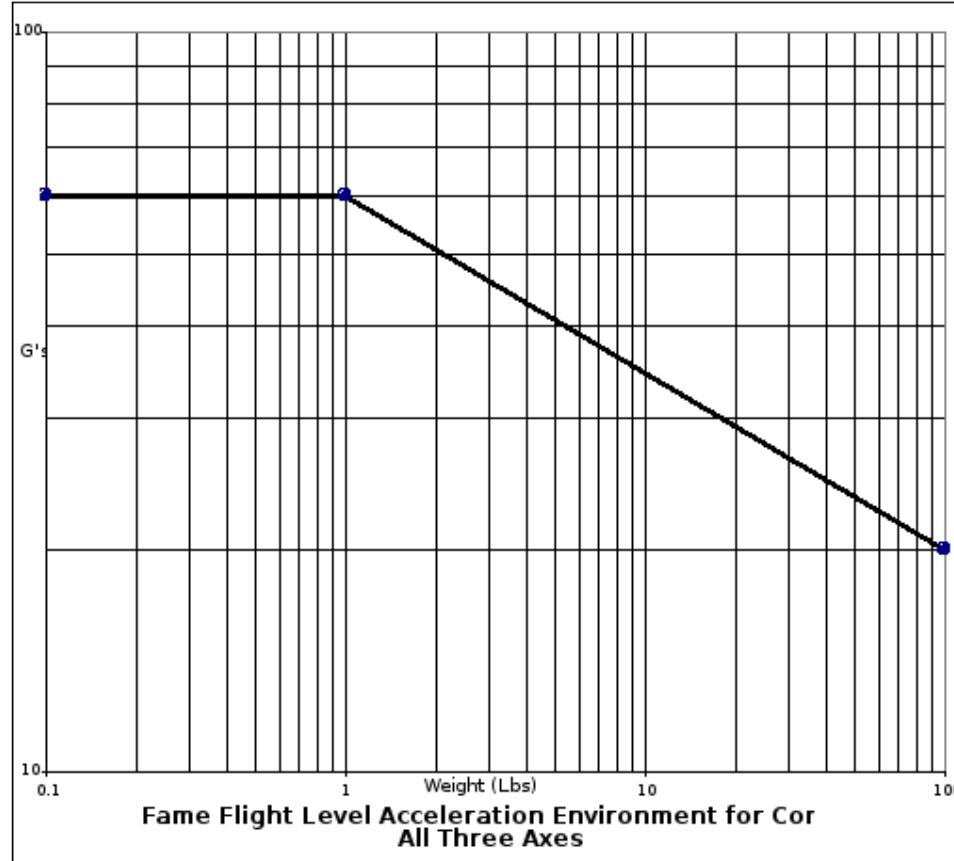
Alignment Knowledge Requirements



Component	Alignment Knowledge Requirement (WRT Bus Ref Axes)	Alignment Reference	Instrumentation	Anticipated Test Set Up
Instrument	± 20 Arc-Sec (TBR)	Optical Cubes	Theodolite	Observatory on Rotary Table, Vertical Bar
StarTrackers	± 10 Arc-Sec	Optical Cubes	Theodolite	Observatory on Rotary Table, Vertical Bar
IMUs	0.01 Degree	Mounting Surface	Reflective Target & Theodolite	Observatory on Rotary Table, Vertical Bar
Spinning Sun Sensors	0.1 Degree	Entrance Slits	Precision Inclinometer	Observatory on Precision Leveled Tooling Plate
Coarse Sun Sensors	1.0 Degree	Entrance Slits	Precision Inclinometer	Observatory on Precision Leveled Tooling Plate
Torque Rods	1.0 Degree	Cylindrical Section	Precision Inclinometer	Observatory on Precision Leveled Tooling Plate
Magnetometer	0.5 Degree	Edge of Component	Precision Inclinometer	Observatory on Precision Leveled Tooling Plate
Solar Array Flatness	5 mm Over 2 Meter Span	Cell Side of Panel	Theodolite	Observatory on Rotary Table, Vertical Bar
Trim Tabs and Trim Areas (Angle)	0.05 Degree	Surface of Trim Tabs & Areas	Theodolite and/or Inclinometer	Observatory on Rotary Table, Vertical Bar
Trim Masses (Installation Angle)	0.05 Degree	Translation Axis	CMM & Theodolite	Inspection of Piece Parts and Assembly (on Tooling Plate)
Propellant Tank	Within 0.05" of Bus CL	Mounting Surface	CMM & Theodolite	Inspection of Piece Parts and Assembly (on Tooling Plate)
5.0Lbf Thrusters	0.1 Degree	Nozzle Exit Plane	Reflective Target & Theodolite	Observatory on Rotary Table, Vertical Bar
0.2Lbf Thrusters	0.1 Degree	Nozzle Exit Plane	Reflective Target & Theodolite	Observatory on Rotary Table, Vertical Bar
AKM	0.1 Degree	AKM Mounting Bolt Circle	CMM & Theodolite	Inspection of Piece Parts and Assembly (on Tooling Plate)



Mass-Acceleration Curve



Design Accelerations

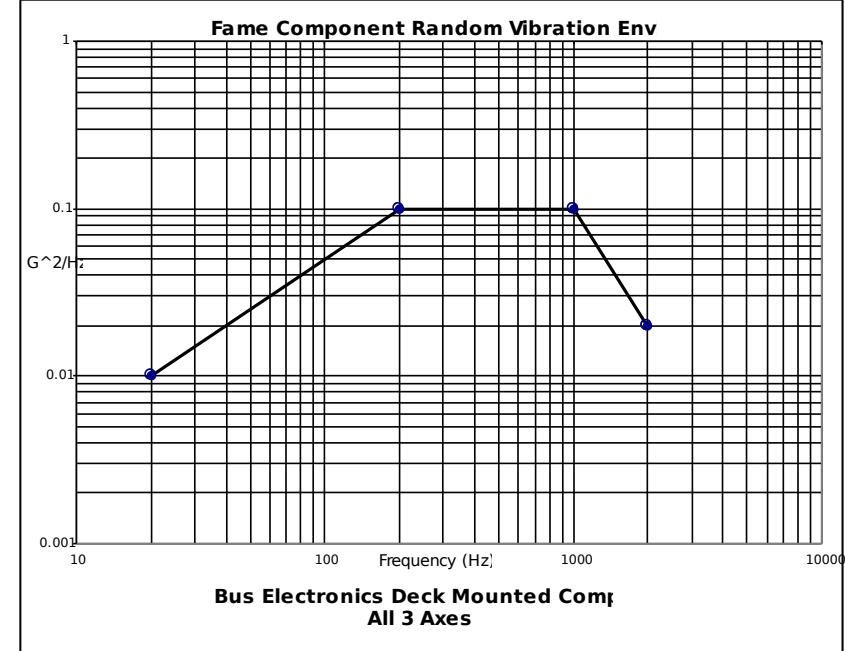
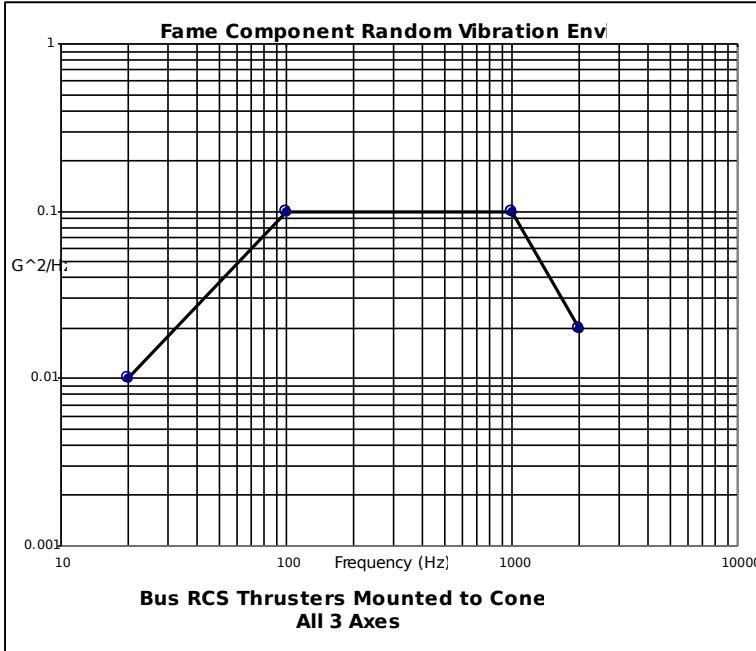
Component Wt. (Lbs)	G's
0.1	60
1	60
100	20

Design Acceleration Philosophy

- * These accelerations are to be used for component testing by sine burst or centrifuge.
- Appropriate factors of safety shall be applied to these accelerations
- For designated components, the acceleration level from this curve may also be used for vibration test tailoring



Bus Component Random Vibration



Flight Level Environment	
Frequency (Hz)	G^2/Hz
20	0.01
100	0.1
1000	0.1
2000	0.02
11.8 Gms	

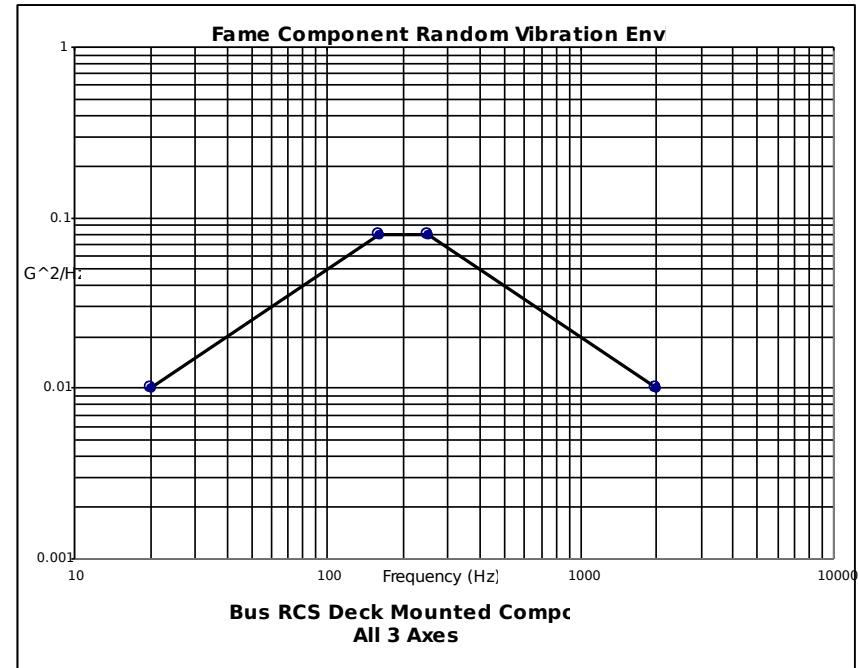
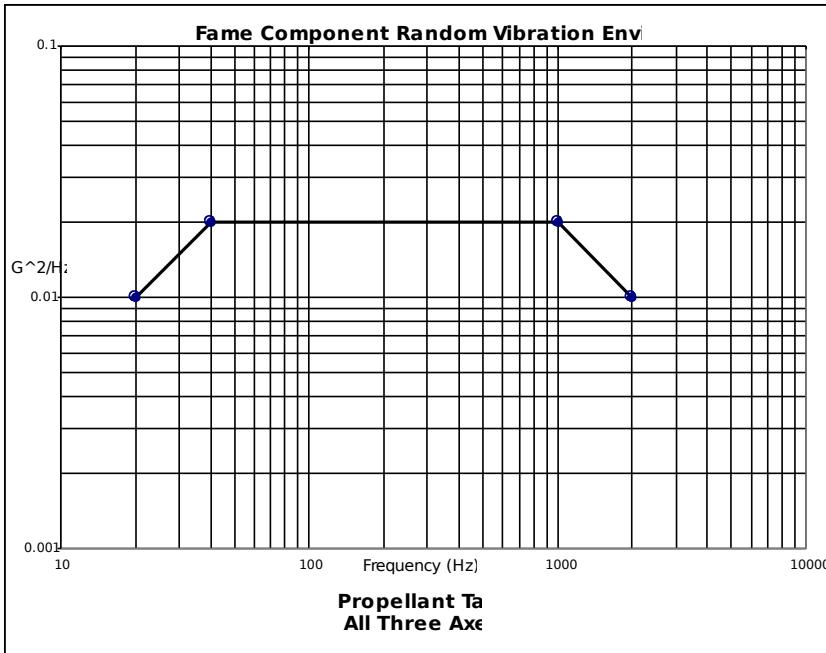
Test Levels			
	Margin Above Flight Level (dB)	Duration (Minutes)	
Non-Flight Prototypes (Design & Qualification Level)	6	2	
Flight Units (Protoflight Acceptance Test)	3	1	

Flight Level Environment	
Frequency (Hz)	G^2/Hz
20	0.01
200	0.1
1000	0.1
2000	0.02
11.6 Grms	

Test Levels			
	Margin Above Flight Level (dB)	Duration (Minutes)	
Non-Flight Prototypes (Design & Qualification Level)	6	2	
Flight Units (Protoflight Acceptance Test)	3	1	



RCS Tank & Deck Random Vibration



Flight Level Environment	
Frequency (Hz)	G^2/Hz
20	0.01
40	0.02
1000	0.02
2000	0.01
5.8 Grms OA	

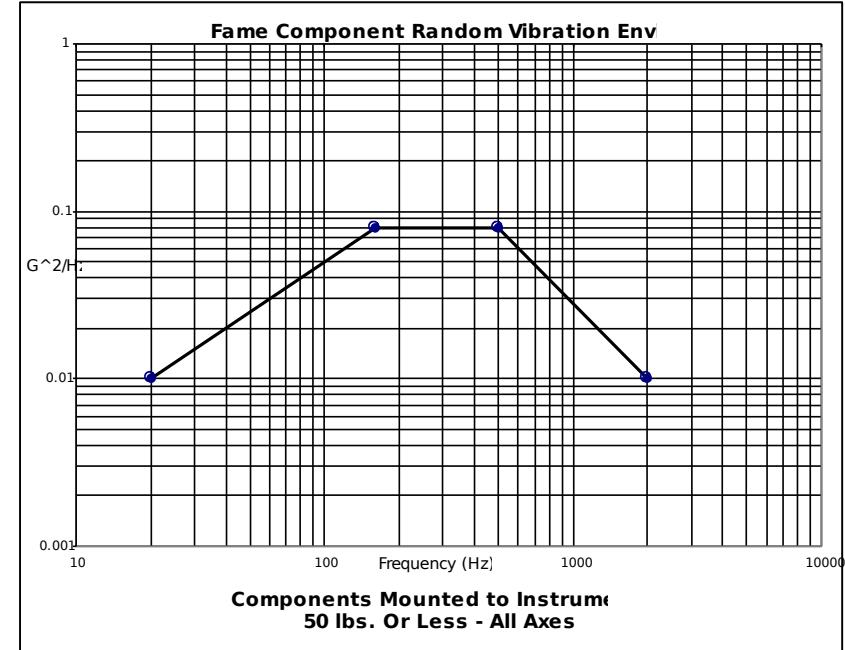
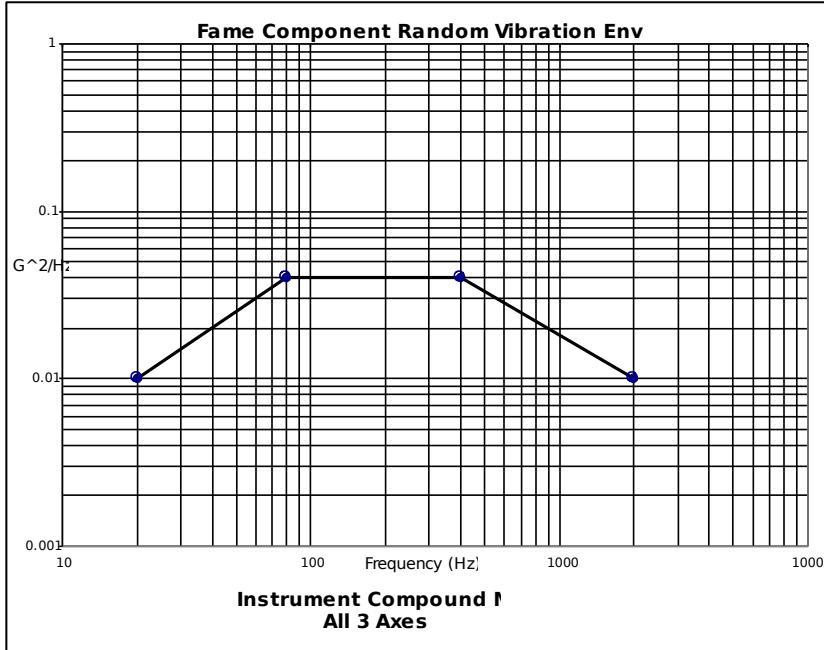
Test Levels			
	Margin Above Flight Level (dB)	Duration (Minutes)	
Non-Flight Prototypes (Design & Qualification Level)	6	2	
Flight Units (Protoflight Acceptance Test)	3	1	

Flight Level Environment			
Frequency (Hz)	G^2/Hz		
20	0.01		
160	0.08		
250	0.08		
2000	0.01		
7.4 Gms			

Test Levels			
	Margin Above Flight Level (dB)	Duration (Minutes)	
Non-Flight Prototypes (Design & Qualification Level)	6	2	
Flight Units (Protoflight Acceptance Test)	3	1	



Compound Mirror & Inst. Deck RV



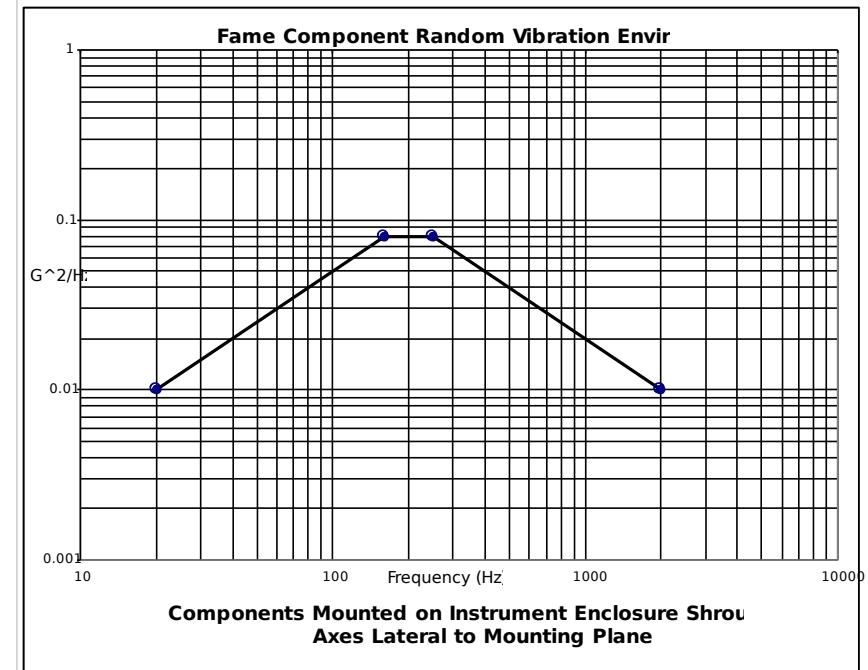
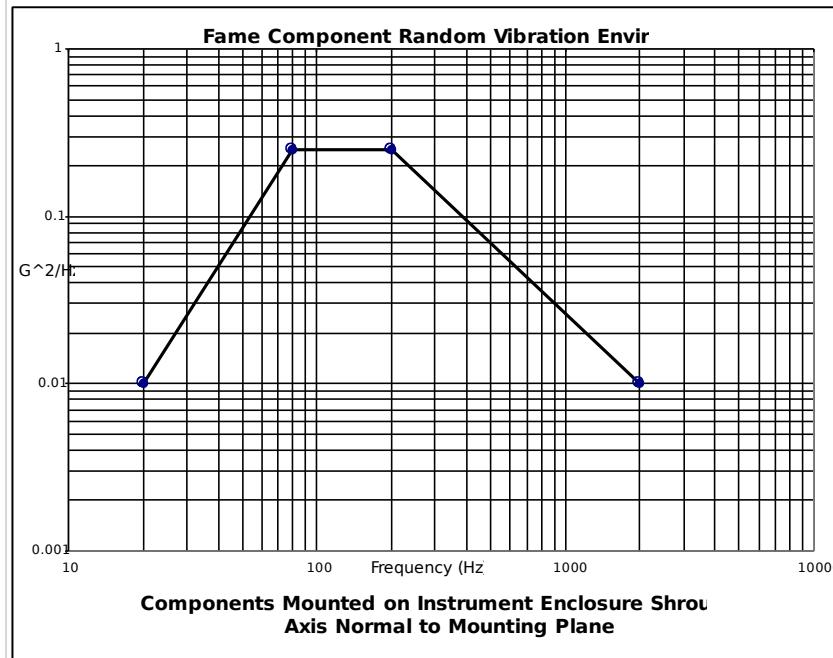
Flight Level Environment	
Frequency (Hz)	G^2/Hz
20	0.01
80	0.04
400	0.04
2000	0.01

Test Levels			
	Margin Above Flight Level (dB)	Duration (Minutes)	
Non-Flight Prototypes (Design & Qualification Level)	6	2	
Flight Units (Protoflight Acceptance Test)	3	1	

Flight Level Environment			
Frequency (Hz)	G^2/Hz	Margin Above Flight Level (dB)	Duration (Minutes)
20	0.01	6	2
160	0.08		
500	0.08		
2000	0.01		



Instrument Enclosure Mounted RV



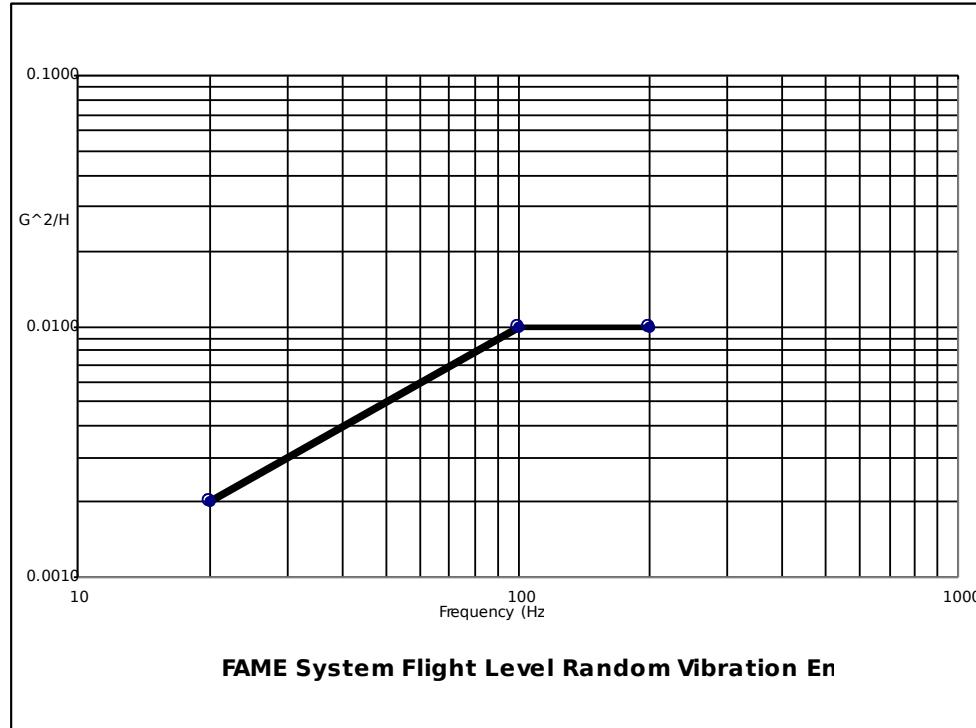
Flight Level Environment	
Frequency (Hz)	G^2/Hz
20	0.01
80	0.25
200	0.25
2000	0.01
10.6 Grms	

Test Levels		
	Margin Above Flight Level (dB)	Duration (Minutes)
Non-Flight Prototypes (Design & Qualification Level)	6	2
Flight Units (Protoflight Acceptance Test)	3	1

Flight Level Environment		
Frequency (Hz)	G^2/Hz	
20	0.01	
160	0.08	
250	0.08	
2000	0.01	
7.4 Grms		
Non-Flight Prototypes (Design & Qualification Level)	6	2
Flight Units (Protoflight Acceptance Test)	3	1



System Level Random Vibration



Flight Level Environment

1.2 Grms Overall

Frequency (Hz)	G^2/Hz
20	0.0020
100	0.0100
200	0.0100

All 3 Axes

Test Level

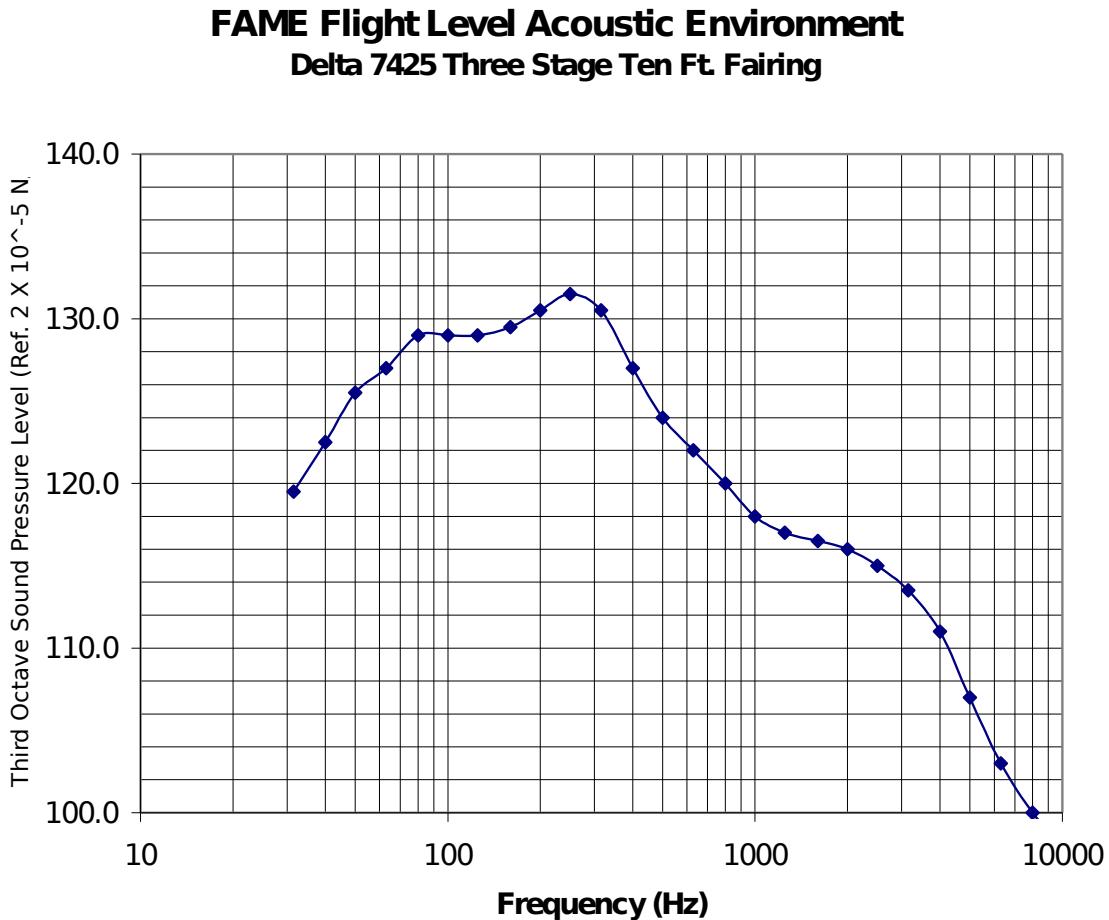
Margin Above Flight Level (dB) Duration (Minutes)

Engineering Model (Qualification Level)	6	2
Flight Spacecraft (Prototyp Acceptance)	3	1

Note: The Spectrum will be tailored to keep primary structural responses below Design Limit Load X 1.05

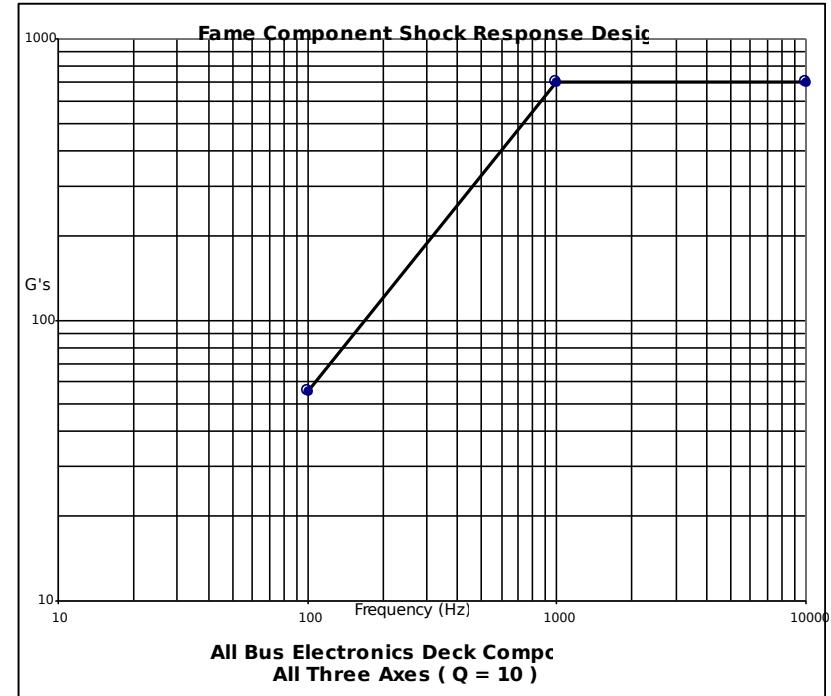
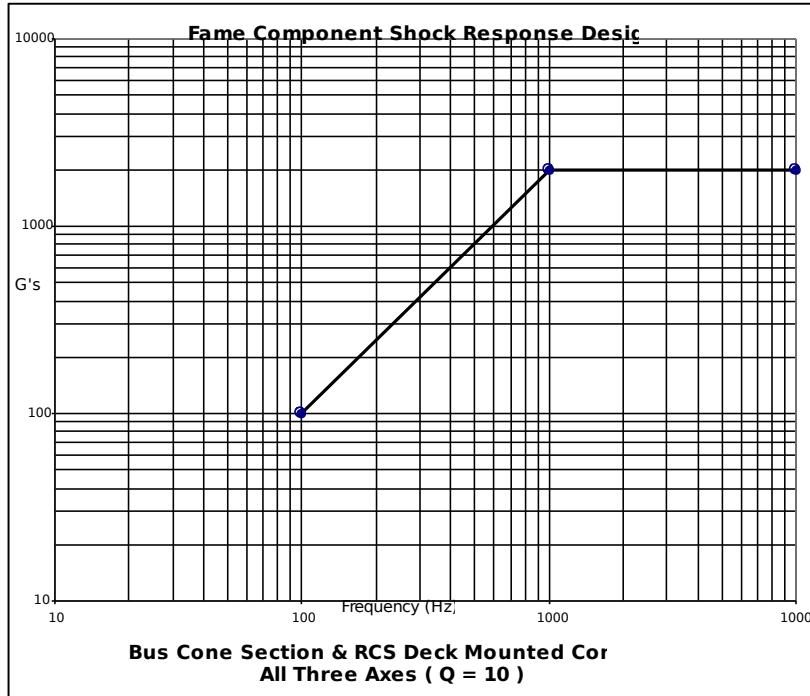


System Acoustic Environment





Component Shock Environment



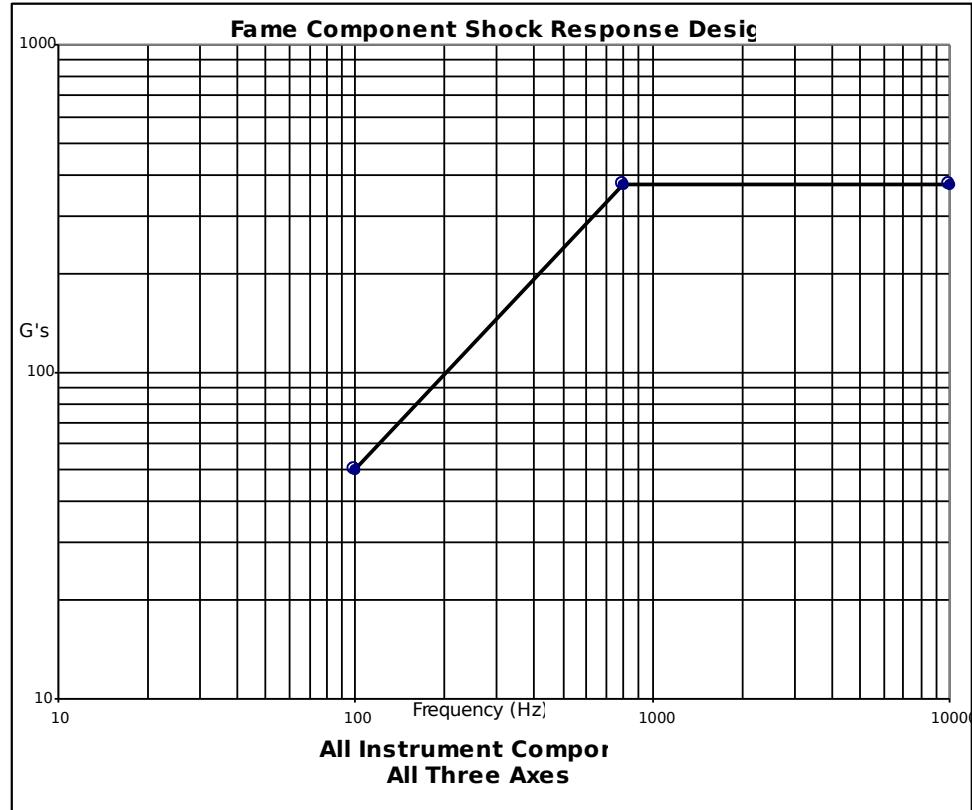
Design Environment Shock Response Spectrum Levels		Test Levels	
Frequency (Hz)	G's	Flight	1 Shock per Axis
100	100	Prototyp	2 Shocks per Axis
1000	2000	Qualification	3 Shocks per Axis
10000	2000		

Design Environment Shock Response Spectrum Levels		Test Levels	
Frequency (Hz)	G's	Flight	1 Shock per Axis
100	56	Prototyp	2 Shocks per Axis
1000	700	Qualification	3 Shocks per Axis
10000	700		



LOCKHEED MARTIN

Instrument Shock Environment

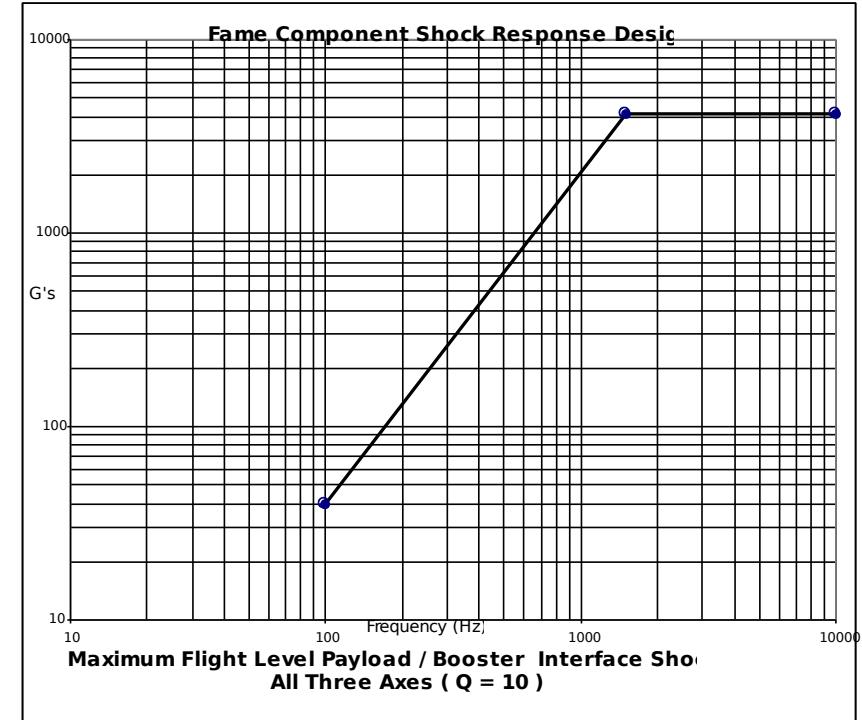
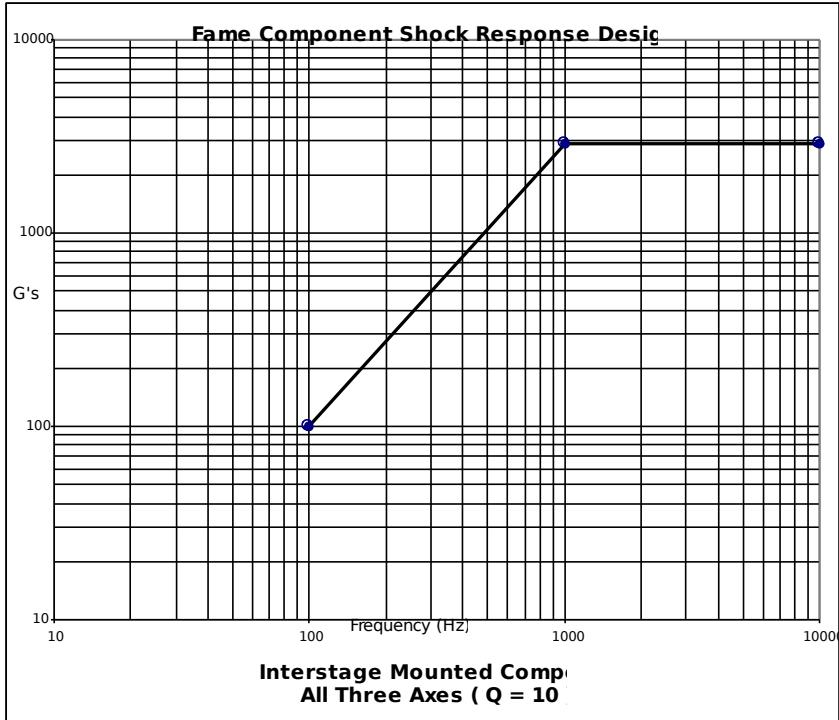


Design Environment Shock Response Spectrum Levels		Test Levels	
Frequency (Hz)	G's		
100	50	Flight	1 Shock per Axis
800	375	Protoflight	2 Shocks per Axis
10000	375	Qualification	3 Shocks per Axis

Q = 10



Interstage & Interface Shock Envir.

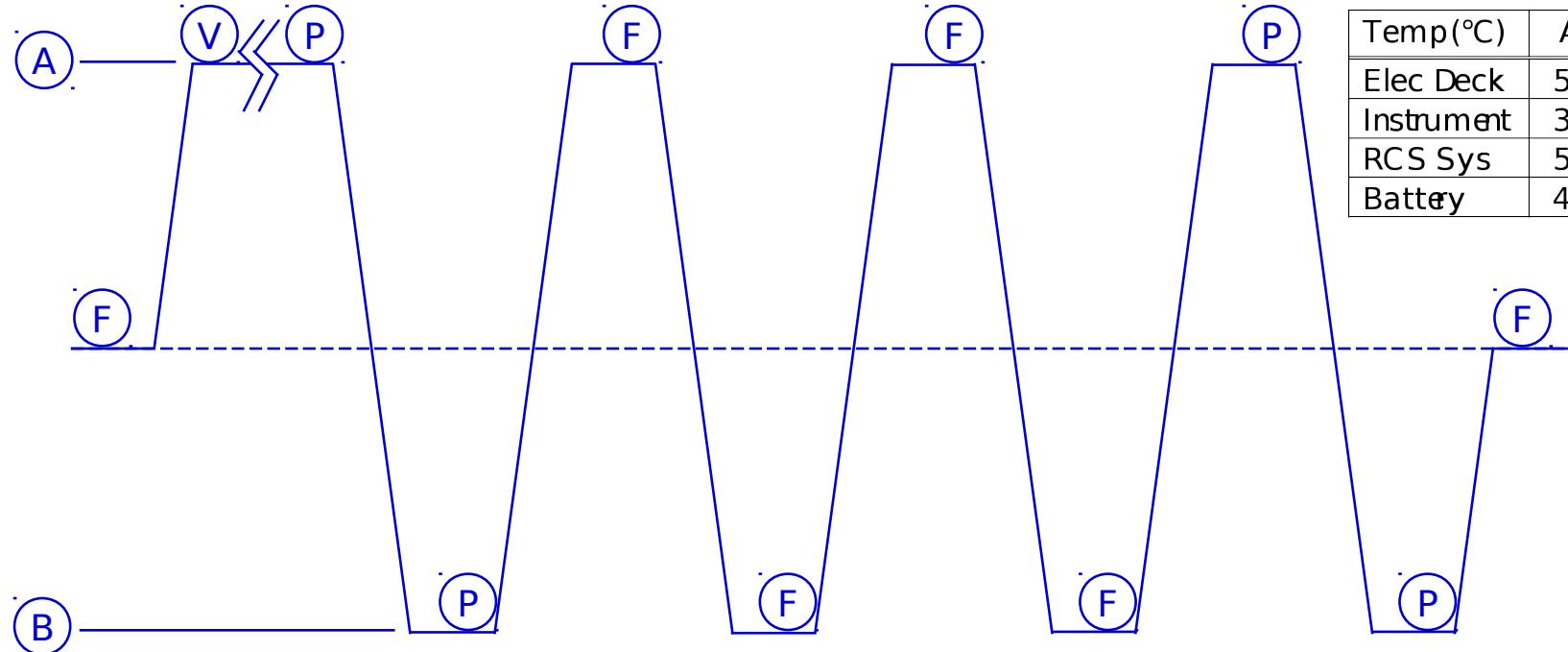


Design Environment Shock Response Spectrum Levels		Test Levels	
Frequency (Hz)	G's	Flight	1 Shock per Axis
100	100	Protoflight	2 Shocks per Axis
1000	2870	Qualification	3 Shocks per Axis
10000	2870		

Maximum Environment Shock Response Spectrum Levels		Test Levels
Frequency (Hz)	G's	N / A
100	40	
1500	4100	
10000	4100	



TVAC Test Profile



Notes:

- Temperature Tolerances: $\pm 2^{\circ}\text{C}$
- Temperature Ramps: $< 1^{\circ}\text{C} / \text{min}$
- 2 Hour Soak at Extremes Prior to Testing
- Will Perform Hot and Cold Start Up Cases
- Will Demonstrate Operation During Ramps
- Vacuum Bake Out Duration Driven by Outgassing Rate as Determined by TQCM

- (V) Vacuum Bake Out
- (F) System Functional Test
- (P) System Performance Test